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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	4.75V ~ 5.25V
Number of Logic Elements/Blocks	4
Number of Macrocells	64
Number of Gates	1250
Number of I/O	68
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epm7064stc100-10n

■ Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, and VeriBest

■ Programming support
    – Altera's Master Programming Unit (MPU) and programming hardware from third-party manufacturers program all MAX 7000 devices
    – The BitBlaster™ serial download cable, ByteBlasterMV™ parallel port download cable, and MasterBlaster™ serial/universal serial bus (USB) download cable program MAX 7000S devices

General Description

The MAX 7000 family of high-density, high-performance PLDs is based on Altera's second-generation MAX architecture. Fabricated with advanced CMOS technology, the EEPROM-based MAX 7000 family provides 600 to 5,000 usable gates, ISP, pin-to-pin delays as fast as 5 ns, and counter speeds of up to 175.4 MHz. MAX 7000S devices in the -5, -6, -7, and -10 speed grades as well as MAX 7000 and MAX 7000E devices in -5, -6, -7, -10P, and -12P speed grades comply with the PCI Special Interest Group (PCI SIG) *PCI Local Bus Specification*, *Revision 2.2*. See Table 3 for available speed grades.

Table 3. MAX 7000 Speed Grades										
Device	Speed Grade									
	-5	-6	-7	-10P	-10	-12P	-12	-15	-15T	-20
EPM7032		✓	✓		✓		✓	✓	✓	
EPM7032S	✓	✓	✓		✓					
EPM7064		✓	✓		✓		✓	✓		
EPM7064S	✓	✓	✓		✓					
EPM7096			✓		✓		✓	✓		
EPM7128E			✓	✓	✓		✓	✓		✓
EPM7128S		✓	✓		✓			✓		
EPM7160E				✓	✓		✓	✓		✓
EPM7160S		✓	✓		✓			✓		
EPM7192E						✓	✓	✓		✓
EPM7192S			✓		✓			✓		
EPM7256E						✓	✓	✓		✓
EPM7256S			✓		✓			✓		

The MAX 7000 architecture supports 100% TTL emulation and high-density integration of SSI, MSI, and LSI logic functions. The MAX 7000 architecture easily integrates multiple devices ranging from PALs, GALs, and 22V10s to MACH and pLSI devices. MAX 7000 devices are available in a wide range of packages, including PLCC, PGA, PQFP, RQFP, and TQFP packages. See Table 5.

Table 5. MAX 7000 Maximum User I/O Pins   *Note (1)*

Device	44-Pin PLCC	44-Pin PQFP	44-Pin TQFP	68-Pin PLCC	84-Pin PLCC	100-Pin PQFP	100-Pin TQFP	160-Pin PQFP	160-Pin PGA	192-Pin PGA	208-Pin PQFP	208-Pin RQFP
EPM7032	36	36	36									
EPM7032S	36		36									
EPM7064	36		36	52	68	68						
EPM7064S	36		36		68		68					
EPM7096				52	64	76						
EPM7128E					68	84		100				
EPM7128S					68	84	84 *(2)*	100				
EPM7160E					64	84		104				
EPM7160S					64		84 *(2)*	104				
EPM7192E								124	124			
EPM7192S								124				
EPM7256E								132 *(2)*		164		164
EPM7256S											164 *(2)*	164

Notes:

(1) When the JTAG interface in MAX 7000S devices is used for either boundary-scan testing or for ISP, four I/O pins become JTAG pins.

(2) Perform a complete thermal analysis before committing a design to this device package. For more information, see the *Operating Requirements for Altera Devices Data Sheet*.

MAX 7000 devices use CMOS EEPROM cells to implement logic functions. The user-configurable MAX 7000 architecture accommodates a variety of independent combinatorial and sequential logic functions. The devices can be reprogrammed for quick and efficient iterations during design development and debug cycles, and can be programmed and erased up to 100 times.

MAX 7000 devices contain from 32 to 256 macrocells that are combined into groups of 16 macrocells, called logic array blocks (LABs). Each macrocell has a programmable-AND/fixed-OR array and a configurable register with independently programmable clock, clock enable, clear, and preset functions. To build complex logic functions, each macrocell can be supplemented with both shareable expander product terms and high-speed parallel expander product terms to provide up to 32 product terms per macrocell.

The MAX 7000 family provides programmable speed/power optimization. Speed-critical portions of a design can run at high speed/full power, while the remaining portions run at reduced speed/low power. This speed/power optimization feature enables the designer to configure one or more macrocells to operate at 50% or lower power while adding only a nominal timing delay. MAX 7000E and MAX 7000S devices also provide an option that reduces the slew rate of the output buffers, minimizing noise transients when non-speed-critical signals are switching. The output drivers of all MAX 7000 devices (except 44-pin devices) can be set for either 3.3-V or 5.0-V operation, allowing MAX 7000 devices to be used in mixed-voltage systems.

The MAX 7000 family is supported byAltera development systems, which are integrated packages that offer schematic, text—including VHDL, Verilog HDL, and the Altera Hardware Description Language (AHDL)—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The software provides EDIF 2 0 0 and 3 0 0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX-workstation-based EDA tools. The software runs on Windows-based PCs, as well as Sun SPARCstation, and HP 9000 Series 700/800 workstations.

For more information on development tools, see the *MAX+PLUS II Programmable Logic Development System & Software Data Sheet* and the *Quartus Programmable Logic Development System & Software Data Sheet*.

Functional Description

The MAX 7000 architecture includes the following elements:

- Logic array blocks
- Macrocells
- Expander product terms (shareable and parallel)
- Programmable interconnect array
- I/O control blocks

Each LAB is fed by the following signals:

■ 36 signals from the PIA that are used for general logic inputs
■ Global controls that are used for secondary register functions
■ Direct input paths from I/O pins to the registers that are used for fast setup times for MAX 7000E and MAX 7000S devices

Macrocells

The MAX 7000 macrocell can be individually configured for either sequential or combinatorial logic operation. The macrocell consists of three functional blocks: the logic array, the product-term select matrix, and the programmable register. The macrocell of EPM7032, EPM7064, and EPM7096 devices is shown in Figure 3.

Figure 3. EPM7032, EPM7064 & EPM7096 Device Macrocell
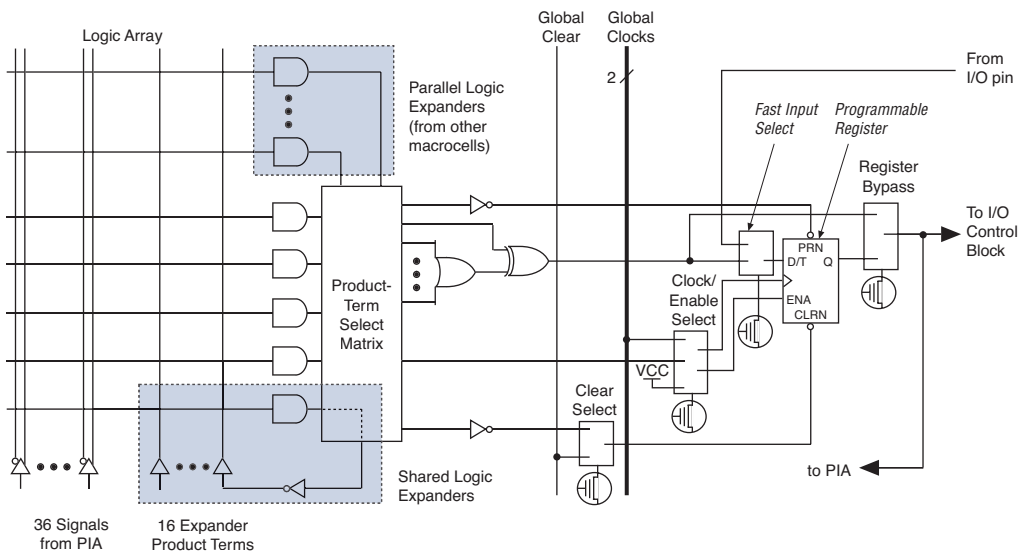
The programming times described in Tables 6 through 8 are associated with the worst-case method using the enhanced ISP algorithm.

Table 6. MAX 7000S t_{PULSE} & Cycle$_{TCK}$ Values

Device	Programming		Stand-Alone Verification	
	t_{PPULSE} (s)	Cycle$_{PTCK}$	t_{VPULSE} (s)	Cycle$_{VTCK}$
EPM7032S	4.02	342,000	0.03	200,000
EPM7064S	4.50	504,000	0.03	308,000
EPM7128S	5.11	832,000	0.03	528,000
EPM7160S	5.35	1,001,000	0.03	640,000
EPM7192S	5.71	1,192,000	0.03	764,000
EPM7256S	6.43	1,603,000	0.03	1,024,000

Tables 7 and 8 show the in-system programming and stand alone verification times for several common test clock frequencies.

Table 7. MAX 7000S In-System Programming Times for Different Test Clock Frequencies

Device	f_{TCK}								Units
	10 MHz	5 MHz	2 MHz	1 MHz	500 kHz	200 kHz	100 kHz	50 kHz	
EPM7032S	4.06	4.09	4.19	4.36	4.71	5.73	7.44	10.86	s
EPM7064S	4.55	4.60	4.76	5.01	5.51	7.02	9.54	14.58	s
EPM7128S	5.19	5.27	5.52	5.94	6.77	9.27	13.43	21.75	s
EPM7160S	5.45	5.55	5.85	6.35	7.35	10.35	15.36	25.37	s
EPM7192S	5.83	5.95	6.30	6.90	8.09	11.67	17.63	29.55	s
EPM7256S	6.59	6.75	7.23	8.03	9.64	14.45	22.46	38.49	s

Table 8. MAX 7000S Stand-Alone Verification Times for Different Test Clock Frequencies

Device	f_{TCK}								Units
	10 MHz	5 MHz	2 MHz	1 MHz	500 kHz	200 kHz	100 kHz	50 kHz	
EPM7032S	0.05	0.07	0.13	0.23	0.43	1.03	2.03	4.03	s
EPM7064S	0.06	0.09	0.18	0.34	0.64	1.57	3.11	6.19	s
EPM7128S	0.08	0.14	0.29	0.56	1.09	2.67	5.31	10.59	s
EPM7160S	0.09	0.16	0.35	0.67	1.31	3.23	6.43	12.83	s
EPM7192S	0.11	0.18	0.41	0.79	1.56	3.85	7.67	15.31	s
EPM7256S	0.13	0.24	0.54	1.06	2.08	5.15	10.27	20.51	s

By using an external 5.0-V pull-up resistor, output pins on MAX 7000S devices can be set to meet 5.0-V CMOS input voltages. When V_{CCIO} is 3.3 V, setting the open drain option will turn off the output pull-up transistor, allowing the external pull-up resistor to pull the output high enough to meet 5.0-V CMOS input voltages. When V_{CCIO} is 5.0 V, setting the output drain option is not necessary because the pull-up transistor will already turn off when the pin exceeds approximately 3.8 V, allowing the external pull-up resistor to pull the output high enough to meet 5.0-V CMOS input voltages.

Slew-Rate Control

The output buffer for each MAX 7000E and MAX 7000S I/O pin has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A faster slew rate provides high-speed transitions for high-performance systems. However, these fast transitions may introduce noise transients into the system. A slow slew rate reduces system noise, but adds a nominal delay of 4 to 5 ns. In MAX 7000E devices, when the Turbo Bit is turned off, the slew rate is set for low noise performance. For MAX 7000S devices, each I/O pin has an individual EEPROM bit that controls the slew rate, allowing designers to specify the slew rate on a pin-by-pin basis.

Programming with External Hardware

MAX 7000 devices can be programmed on Windows-based PCs with the Altera Logic Programmer card, the Master Programming Unit (MPU), and the appropriate device adapter. The MPU performs a continuity check to ensure adequate electrical contact between the adapter and the device.

For more information, see the *Altera Programming Hardware Data Sheet*.

The Altera development system can use text- or waveform-format test vectors created with the Text Editor or Waveform Editor to test the programmed device. For added design verification, designers can perform functional testing to compare the functional behavior of a MAX 7000 device with the results of simulation. Moreover, Data I/O, BP Microsystems, and other programming hardware manufacturers also provide programming support for Altera devices.

For more information, see the *Programming Hardware Manufacturers*.

Operating Conditions

Tables 13 through 18 provide information about absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 5.0-V MAX 7000 devices.

Table 13. MAX 7000 5.0-V Device Absolute Maximum Ratings   *Note (1)*

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply voltage	With respect to ground *(2)*	−2.0	7.0	V
V_I	DC input voltage		−2.0	7.0	V
I_{OUT}	DC output current, per pin		−25	25	mA
T_{STG}	Storage temperature	No bias	−65	150	° C
T_{AMB}	Ambient temperature	Under bias	−65	135	° C
T_J	Junction temperature	Ceramic packages, under bias		150	° C
		PQFP and RQFP packages, under bias		135	° C

Table 14. MAX 7000 5.0-V Device Recommended Operating Conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CCINT}	Supply voltage for internal logic and input buffers	*(3)*, *(4)*, *(5)*	4.75 (4.50)	5.25 (5.50)	V
V_{CCIO}	Supply voltage for output drivers, 5.0-V operation	*(3)*, *(4)*	4.75 (4.50)	5.25 (5.50)	V
	Supply voltage for output drivers, 3.3-V operation	*(3)*, *(4)*, *(6)*	3.00 (3.00)	3.60 (3.60)	V
V_{CCISP}	Supply voltage during ISP	*(7)*	4.75	5.25	V
V_I	Input voltage		−0.5 *(8)*	V_{CCINT} + 0.5	V
V_O	Output voltage		0	V_{CCIO}	V
T_A	Ambient temperature	For commercial use	0	70	° C
		For industrial use	−40	85	° C
T_J	Junction temperature	For commercial use	0	90	° C
		For industrial use	−40	105	° C
t_R	Input rise time			40	ns
t_F	Input fall time			40	ns

Table 15. MAX 7000 5.0-V Device DC Operating Conditions   *Note (9)*

Symbol	Parameter	Conditions	Min	Max	Unit
V_{IH}	High-level input voltage		2.0	V_{CCINT} + 0.5	V
V_{IL}	Low-level input voltage		−0.5 *(8)*	0.8	V
V_{OH}	5.0-V high-level TTL output voltage	I_{OH} = −4 mA DC, V_{CCIO} = 4.75 V *(10)*	2.4		V
	3.3-V high-level TTL output voltage	I_{OH} = −4 mA DC, V_{CCIO} = 3.00 V *(10)*	2.4		V
	3.3-V high-level CMOS output voltage	I_{OH} = −0.1 mA DC, V_{CCIO} = 3.0 V *(10)*	V_{CCIO} − 0.2		V
V_{OL}	5.0-V low-level TTL output voltage	I_{OL} = 12 mA DC, V_{CCIO} = 4.75 V *(11)*		0.45	V
	3.3-V low-level TTL output voltage	I_{OL} = 12 mA DC, V_{CCIO} = 3.00 V *(11)*		0.45	V
	3.3-V low-level CMOS output voltage	I_{OL} = 0.1 mA DC, V_{CCIO} = 3.0 V *(11)*		0.2	V
I_I	Leakage current of dedicated input pins	V_I = −0.5 to 5.5 V *(11)*	−10	10	μA
I_{OZ}	I/O pin tri-state output off-state current	V_I = −0.5 to 5.5 V *(11)*, *(12)*	−40	40	μA

Table 16. MAX 7000 5.0-V Device Capacitance: EPM7032, EPM7064 & EPM7096 Devices   *Note (13)*

Symbol	Parameter	Conditions	Min	Max	Unit
C_{IN}	Input pin capacitance	V_{IN} = 0 V, f = 1.0 MHz		12	pF
$C_{I/O}$	I/O pin capacitance	V_{OUT} = 0 V, f = 1.0 MHz		12	pF

## *Table 17. MAX 7000 5.0-V Device Capacitance: MAX 7000E Devices*   *Note (13)*

Symbol	Parameter	Conditions	Min	Max	Unit
C_{IN}	Input pin capacitance	V_{IN} = 0 V, f = 1.0 MHz		15	pF
$C_{I/O}$	I/O pin capacitance	V_{OUT} = 0 V, f = 1.0 MHz		15	pF

Table 18. MAX 7000 5.0-V Device Capacitance: MAX 7000S Devices   *Note (13)*

Symbol	Parameter	Conditions	Min	Max	Unit
C_{IN}	Dedicated input pin capacitance	V_{IN} = 0 V, f = 1.0 MHz		10	pF
$C_{I/O}$	I/O pin capacitance	V_{OUT} = 0 V, f = 1.0 MHz		10	pF

Notes to tables:

(1) See the *Operating Requirements for Altera Devices Data Sheet*.
(2) Minimum DC input voltage on I/O pins is –0.5 V and on 4 dedicated input pins is –0.3 V. During transitions, the inputs may undershoot to –2.0 V or overshoot to 7.0 V for input currents less than 100 mA and periods shorter than 20 ns.
(3) Numbers in parentheses are for industrial-temperature-range devices.
(4) V_{CC} must rise monotonically.
(5) The POR time for all 7000S devices does not exceed 300 μs. The sufficient V_{CCINT} voltage level for POR is 4.5 V. The device is fully initialized within the POR time after V_{CCINT} reaches the sufficient POR voltage level.
(6) 3.3-V I/O operation is not available for 44-pin packages.
(7) The V_{CCISP} parameter applies only to MAX 7000S devices.
(8) During in-system programming, the minimum DC input voltage is –0.3 V.
(9) These values are specified under the MAX 7000 recommended operating conditions in Table 14 on page 26.
(10) The parameter is measured with 50% of the outputs each sourcing the specified current. The I_{OH} parameter refers to high-level TTL or CMOS output current.
(11) The parameter is measured with 50% of the outputs each sinking the specified current. The I_{OL} parameter refers to low-level TTL, PCI, or CMOS output current.
(12) When the JTAG interface is enabled in MAX 7000S devices, the input leakage current on the JTAG pins is typically –60 μA.
(13) Capacitance is measured at 25° C and is sample-tested only. The OE1 pin has a maximum capacitance of 20 pF.

Figure 11 shows the typical output drive characteristics of MAX 7000 devices.

Figure 11. Output Drive Characteristics of 5.0-V MAX 7000 Devices
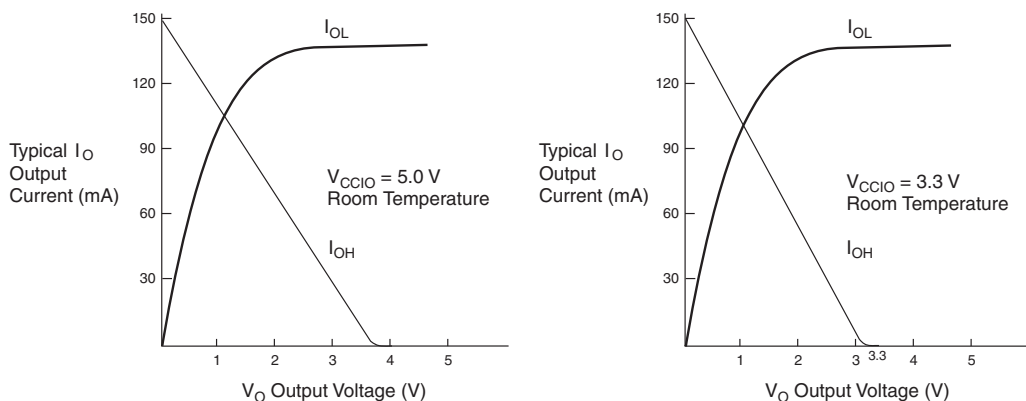
Timing Model

MAX 7000 device timing can be analyzed with the Altera software, with a variety of popular industry-standard EDA simulators and timing analyzers, or with the timing model shown in Figure 12. MAX 7000 devices have fixed internal delays that enable the designer to determine the worst-case timing of any design. The Altera software provides timing simulation, point-to-point delay prediction, and detailed timing analysis for a device-wide performance evaluation.

Figure 12. MAX 7000 Timing Model
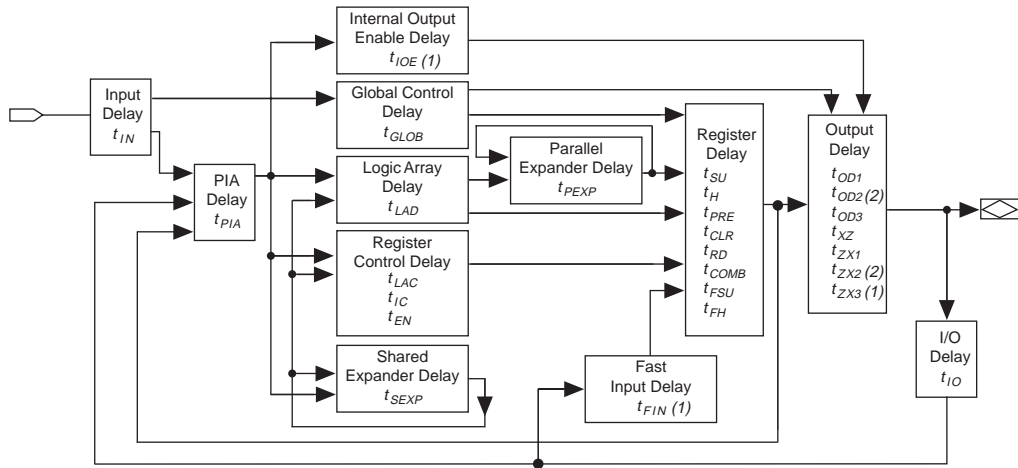
Notes:
(1)   Only available in MAX 7000E and MAX 7000S devices.
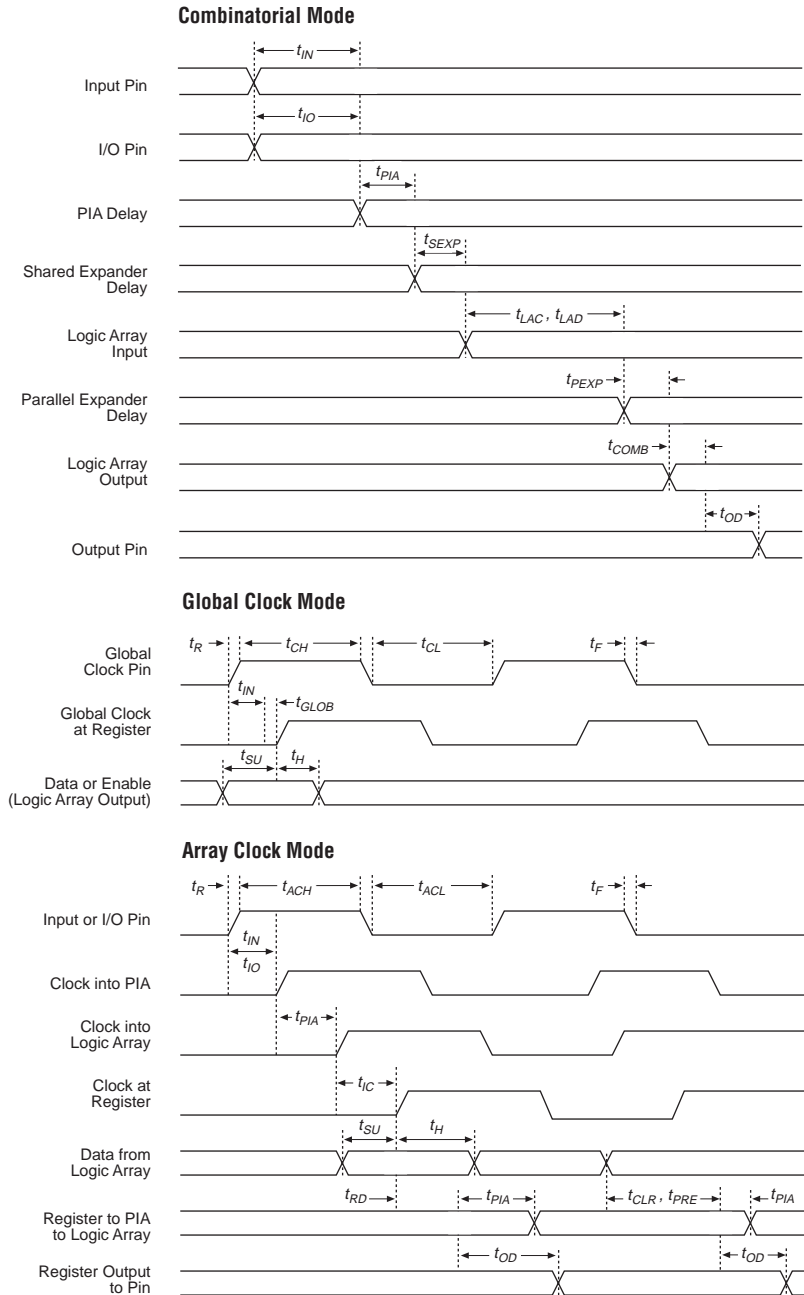(2)   Not available in 44-pin devices.

The timing characteristics of any signal path can be derived from the timing model and parameters of a particular device. External timing parameters, which represent pin-to-pin timing delays, can be calculated as the sum of internal parameters. Figure 13 shows the internal timing relationship of internal and external delay parameters.

For more infomration, see *Application Note 94 (Understanding MAX 7000 Timing)*.

Figure 13. Switching Waveforms

t_R & t_F < 3 ns.
Inputs are driven at 3 V
for a logic high and 0 V
for a logic low. All timing
characteristics are
measured at 1.5 V.

Combinatorial Mode

Input Pin

I/O Pin

PIA Delay

Shared Expander Delay

Logic Array Input

Parallel Expander Delay

Logic Array Output

Output Pin

Global Clock Mode

Global Clock Pin

Global Clock at Register

Data or Enable (Logic Array Output)

Array Clock Mode

Input or I/O Pin

Clock into PIA

Clock into Logic Array

Clock at Register

Data from Logic Array

Register to PIA to Logic Array

Register Output to Pin

Tables 19 through 26 show the MAX 7000 and MAX 7000E AC operating conditions.

Symbol	Parameter	Conditions	-6 Speed Grade		-7 Speed Grade		Unit
			Min	Max	Min	Max	
t$_{PD1}$	Input to non-registered output	C1 = 35 pF		6.0		7.5	ns
t$_{PD2}$	I/O input to non-registered output	C1 = 35 pF		6.0		7.5	ns
t$_{SU}$	Global clock setup time		5.0		6.0		ns
t$_H$	Global clock hold time		0.0		0.0		ns
t$_{FSU}$	Global clock setup time of fast input	(2)	2.5		3.0		ns
t$_{FH}$	Global clock hold time of fast input	(2)	0.5		0.5		ns
t$_{CO1}$	Global clock to output delay	C1 = 35 pF		4.0		4.5	ns
t$_{CH}$	Global clock high time		2.5		3.0		ns
t$_{CL}$	Global clock low time		2.5		3.0		ns
t$_{ASU}$	Array clock setup time		2.5		3.0		ns
t$_{AH}$	Array clock hold time		2.0		2.0		ns
t$_{ACO1}$	Array clock to output delay	C1 = 35 pF		6.5		7.5	ns
t$_{ACH}$	Array clock high time		3.0		3.0		ns
t$_{ACL}$	Array clock low time		3.0		3.0		ns
t$_{CPPW}$	Minimum pulse width for clear and preset	(3)	3.0		3.0		ns
t$_{ODH}$	Output data hold time after clock	C1 = 35 pF (4)	1.0		1.0		ns
t$_{CNT}$	Minimum global clock period			6.6		8.0	ns
f$_{CNT}$	Maximum internal global clock frequency	(5)	151.5		125.0		MHz
t$_{ACNT}$	Minimum array clock period			6.6		8.0	ns
f$_{ACNT}$	Maximum internal array clock frequency	(5)	151.5		125.0		MHz
f$_{MAX}$	Maximum clock frequency	(6)	200		166.7		MHz

Table 19. MAX 7000 & MAX 7000E External Timing Parameters Note (1)

Table 23. MAX 7000 & MAX 7000E External Timing Parameters   *Note (1)*

Symbol	Parameter	Conditions	Speed Grade				Unit
			MAX 7000E (-12P)		MAX 7000 (-12) MAX 7000E (-12)		
			Min	Max	Min	Max	
t$_{PD1}$	Input to non-registered output	C1 = 35 pF		12.0		12.0	ns
t$_{PD2}$	I/O input to non-registered output	C1 = 35 pF		12.0		12.0	ns
t$_{SU}$	Global clock setup time		7.0		10.0		ns
t$_{H}$	Global clock hold time		0.0		0.0		ns
t$_{FSU}$	Global clock setup time of fast input	*(2)*	3.0		3.0		ns
t$_{FH}$	Global clock hold time of fast input	*(2)*	0.0		0.0		ns
t$_{CO1}$	Global clock to output delay	C1 = 35 pF		6.0		6.0	ns
t$_{CH}$	Global clock high time		4.0		4.0		ns
t$_{CL}$	Global clock low time		4.0		4.0		ns
t$_{ASU}$	Array clock setup time		3.0		4.0		ns
t$_{AH}$	Array clock hold time		4.0		4.0		ns
t$_{ACO1}$	Array clock to output delay	C1 = 35 pF		12.0		12.0	ns
t$_{ACH}$	Array clock high time		5.0		5.0		ns
t$_{ACL}$	Array clock low time		5.0		5.0		ns
t$_{CPPW}$	Minimum pulse width for clear and preset	*(3)*	5.0		5.0		ns
t$_{ODH}$	Output data hold time after clock	C1 = 35 pF *(4)*	1.0		1.0		ns
t$_{CNT}$	Minimum global clock period			11.0		11.0	ns
f$_{CNT}$	Maximum internal global clock frequency	*(5)*	90.9		90.9		MHz
t$_{ACNT}$	Minimum array clock period			11.0		11.0	ns
f$_{ACNT}$	Maximum internal array clock frequency	*(5)*	90.9		90.9		MHz
f$_{MAX}$	Maximum clock frequency	*(6)*	125.0		125.0		MHz

Table 28. EPM7032S Internal Timing Parameters Note (1)

Symbol	Parameter	Conditions	Speed Grade								Unit
			-5		-6		-7		-10		
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{PIA}	PIA delay	(7)		1.1		1.1		1.4		1.0	ns
t_{LPA}	Low-power adder	(8)		12.0		10.0		10.0		11.0	ns

Notes to tables:
(1)   These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
(2)   This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
(3)   This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
(4)   These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
(5)   The f_{MAX} values represent the highest frequency for pipelined data.
(6)   Operating conditions: V_{CCIO} = 3.3 V ± 10% for commercial and industrial use.
(7)   For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
(8)   The t_{LPA} parameter must be added to the t_{LAD}, t_{LAC}, t_{IC}, t_{EN}, t_{SEXP}, $\mathbf{t_{ACL}}$, and $\mathbf{t_{CPPW}}$ parameters for macrocells running in the low-power mode.

Tables 29 and 30 show the EPM7064S AC operating conditions.

Table 29. EPM7064S External Timing Parameters (Part 1 of 2) Note (1)

Symbol	Parameter	Conditions	Speed Grade								Unit
			-5		-6		-7		-10		
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{PD1}	Input to non-registered output	C1 = 35 pF		5.0		6.0		7.5		10.0	ns
t_{PD2}	I/O input to non-registered output	C1 = 35 pF		5.0		6.0		7.5		10.0	ns
t_{SU}	Global clock setup time		2.9		3.6		6.0		7.0		ns
t_H	Global clock hold time		0.0		0.0		0.0		0.0		ns
t_{FSU}	Global clock setup time of fast input		2.5		2.5		3.0		3.0		ns
t_{FH}	Global clock hold time of fast input		0.0		0.0		0.5		0.5		ns
t_{CO1}	Global clock to output delay	C1 = 35 pF		3.2		4.0		4.5		5.0	ns
t_{CH}	Global clock high time		2.0		2.5		3.0		4.0		ns
t_{CL}	Global clock low time		2.0		2.5		3.0		4.0		ns
t_{ASU}	Array clock setup time		0.7		0.9		3.0		2.0		ns
t_{AH}	Array clock hold time		1.8		2.1		2.0		3.0		ns

Tables 31 and 32 show the EPM7128S AC operating conditions.

Symbol	Parameter	Conditions	Speed Grade								Unit
			-6		**-7**		**-10**		**-15**		
			Min	Max	Min	Max	Min	Max	Min	Max	
t$_{PD1}$	Input to non-registered output	C1 = 35 pF		6.0		7.5		10.0		15.0	ns
t$_{PD2}$	I/O input to non-registered output	C1 = 35 pF		6.0		7.5		10.0		15.0	ns
t$_{SU}$	Global clock setup time		3.4		6.0		7.0		11.0		ns
t$_H$	Global clock hold time		0.0		0.0		0.0		0.0		ns
t$_{FSU}$	Global clock setup time of fast input		2.5		3.0		3.0		3.0		ns
t$_{FH}$	Global clock hold time of fast input		0.0		0.5		0.5		0.0		ns
t$_{CO1}$	Global clock to output delay	C1 = 35 pF		4.0		4.5		5.0		8.0	ns
t$_{CH}$	Global clock high time		3.0		3.0		4.0		5.0		ns
t$_{CL}$	Global clock low time		3.0		3.0		4.0		5.0		ns
t$_{ASU}$	Array clock setup time		0.9		3.0		2.0		4.0		ns
t$_{AH}$	Array clock hold time		1.8		2.0		5.0		4.0		ns
t$_{ACO1}$	Array clock to output delay	C1 = 35 pF		6.5		7.5		10.0		15.0	ns
t$_{ACH}$	Array clock high time		3.0		3.0		4.0		6.0		ns
t$_{ACL}$	Array clock low time		3.0		3.0		4.0		6.0		ns
t$_{CPPW}$	Minimum pulse width for clear and preset	(2)	3.0		3.0		4.0		6.0		ns
t$_{ODH}$	Output data hold time after clock	C1 = 35 pF (3)	1.0		1.0		1.0		1.0		ns
t$_{CNT}$	Minimum global clock period			6.8		8.0		10.0		13.0	ns
f$_{CNT}$	Maximum internal global clock frequency	(4)	147.1		125.0		100.0		76.9		MHz
t$_{ACNT}$	Minimum array clock period			6.8		8.0		10.0		13.0	ns
f$_{ACNT}$	Maximum internal array clock frequency	(4)	147.1		125.0		100.0		76.9		MHz
f$_{MAX}$	Maximum clock frequency	(5)	166.7		166.7		125.0		100.0		MHz

Table 31. EPM7128S External Timing Parameters   *Note (1)*

Table 33. EPM7160S External Timing Parameters (Part 2 of 2)   Note (1)

Symbol	Parameter	Conditions	Speed Grade								Unit
			-6		**-7**		**-10**		**-15**		
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{ACNT}	Minimum array clock period			6.7		8.2		10.0		13.0	ns
f_{ACNT}	Maximum internal array clock frequency	(4)	149.3		122.0		100.0		76.9		MHz
f_{MAX}	Maximum clock frequency	(5)	166.7		166.7		125.0		100.0		MHz

Table 34. EPM7160S Internal Timing Parameters (Part 1 of 2)   Note (1)

Symbol	Parameter	Conditions	Speed Grade								Unit
			-6		**-7**		**-10**		**-15**		
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{IN}	Input pad and buffer delay			0.2		0.3		0.5		2.0	ns
t_{IO}	I/O input pad and buffer delay			0.2		0.3		0.5		2.0	ns
t_{FIN}	Fast input delay			2.6		3.2		1.0		2.0	ns
t_{SEXP}	Shared expander delay			3.6		4.3		5.0		8.0	ns
t_{PEXP}	Parallel expander delay			1.0		1.3		0.8		1.0	ns
t_{LAD}	Logic array delay			2.8		3.4		5.0		6.0	ns
t_{LAC}	Logic control array delay			2.8		3.4		5.0		6.0	ns
t_{IOE}	Internal output enable delay			0.7		0.9		2.0		3.0	ns
t_{OD1}	Output buffer and pad delay	C1 = 35 pF		0.4		0.5		1.5		4.0	ns
t_{OD2}	Output buffer and pad delay	C1 = 35 pF (6)		0.9		1.0		2.0		5.0	ns
t_{OD3}	Output buffer and pad delay	C1 = 35 pF		5.4		5.5		5.5		8.0	ns
t_{ZX1}	Output buffer enable delay	C1 = 35 pF		4.0		4.0		5.0		6.0	ns
t_{ZX2}	Output buffer enable delay	C1 = 35 pF (6)		4.5		4.5		5.5		7.0	ns
t_{ZX3}	Output buffer enable delay	C1 = 35 pF		9.0		9.0		9.0		10.0	ns
t_{XZ}	Output buffer disable delay	C1 = 5 pF		4.0		4.0		5.0		6.0	ns
t_{SU}	Register setup time		1.0		1.2		2.0		4.0		ns
t_{H}	Register hold time		1.6		2.0		3.0		4.0		ns
t_{FSU}	Register setup time of fast input		1.9		2.2		3.0		2.0		ns
t_{FH}	Register hold time of fast input		0.6		0.8		0.5		1.0		ns
t_{RD}	Register delay			1.3		1.6		2.0		1.0	ns
t_{COMB}	Combinatorial delay			1.0		1.3		2.0		1.0	ns
t_{IC}	Array clock delay			2.9		3.5		5.0		6.0	ns
t_{EN}	Register enable time			2.8		3.4		5.0		6.0	ns
t_{GLOB}	Global control delay			2.0		2.4		1.0		1.0	ns
t_{PRE}	Register preset time			2.4		3.0		3.0		4.0	ns

Tables 37 and 38 show the EPM7256S AC operating conditions.

Table 37. EPM7256S External Timing Parameters   *Note (1)*

Symbol	Parameter	Conditions	Speed Grade						Unit
			-7		-10		-15		
			Min	Max	Min	Max	Min	Max	
t_{PD1}	Input to non-registered output	C1 = 35 pF		7.5		10.0		15.0	ns
t_{PD2}	I/O input to non-registered output	C1 = 35 pF		7.5		10.0		15.0	ns
t_{SU}	Global clock setup time		3.9		7.0		11.0		ns
t_H	Global clock hold time		0.0		0.0		0.0		ns
t_{FSU}	Global clock setup time of fast input		3.0		3.0		3.0		ns
t_{FH}	Global clock hold time of fast input		0.0		0.5		0.0		ns
t_{CO1}	Global clock to output delay	C1 = 35 pF		4.7		5.0		8.0	ns
t_{CH}	Global clock high time		3.0		4.0		5.0		ns
t_{CL}	Global clock low time		3.0		4.0		5.0		ns
t_{ASU}	Array clock setup time		0.8		2.0		4.0		ns
t_{AH}	Array clock hold time		1.9		3.0		4.0		ns
t_{ACO1}	Array clock to output delay	C1 = 35 pF		7.8		10.0		15.0	ns
t_{ACH}	Array clock high time		3.0		4.0		6.0		ns
t_{ACL}	Array clock low time		3.0		4.0		6.0		ns
t_{CPPW}	Minimum pulse width for clear and preset	*(2)*	3.0		4.0		6.0		ns
t_{ODH}	Output data hold time after clock	C1 = 35 pF *(3)*	1.0		1.0		1.0		ns
t_{CNT}	Minimum global clock period			7.8		10.0		13.0	ns
f_{CNT}	Maximum internal global clock frequency	*(4)*	128.2		100.0		76.9		MHz
t_{ACNT}	Minimum array clock period			7.8		10.0		13.0	ns
f_{ACNT}	Maximum internal array clock frequency	*(4)*	128.2		100.0		76.9		MHz
f_{MAX}	Maximum clock frequency	*(5)*	166.7		125.0		100.0		MHz

Figure 14 shows typical supply current versus frequency for MAX 7000 devices.

Figure 14. I$_{CC}$ vs. Frequency for MAX 7000 Devices (Part 1 of 2)
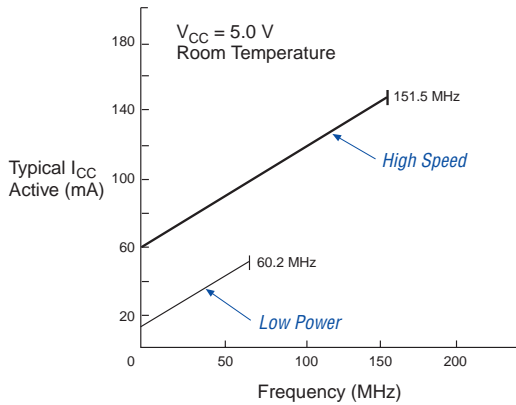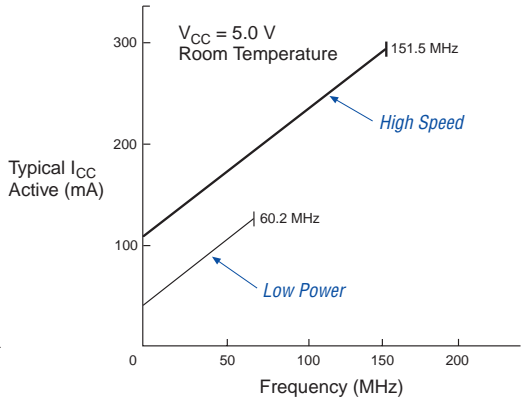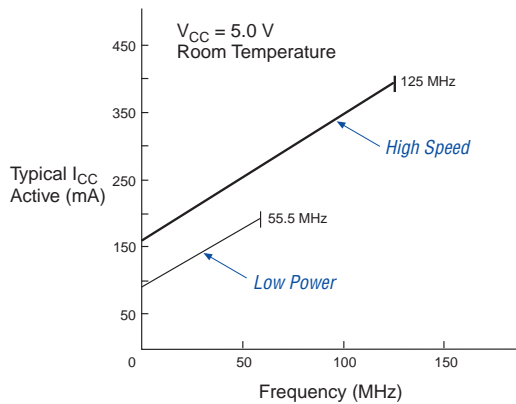
Figure 19. 100-Pin Package Pin-Out Diagram
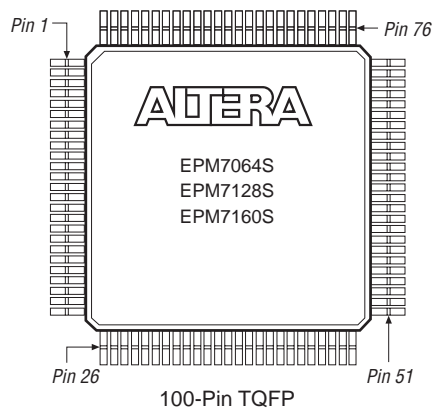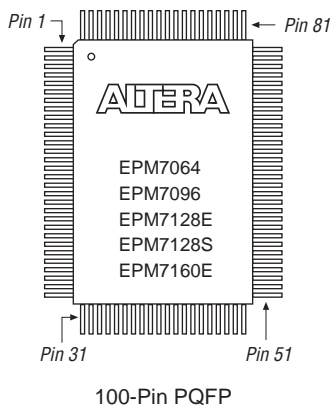
Package outline not drawn to scale.

Pin 1 ← Pin 81
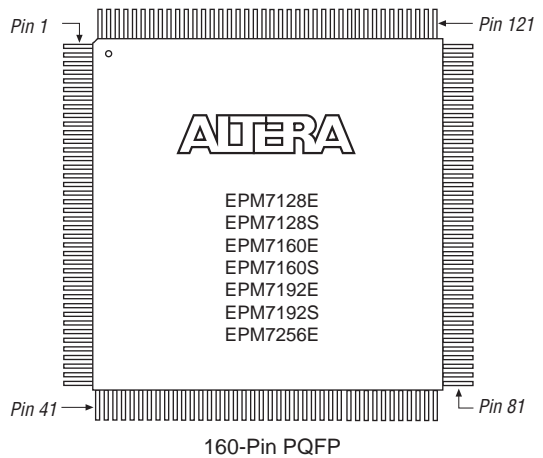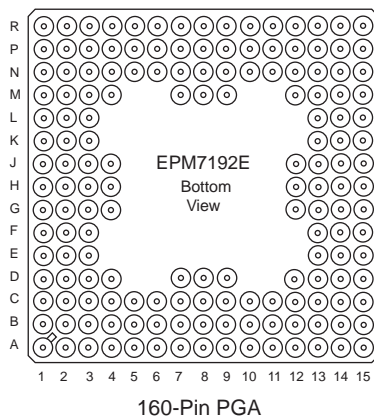
ALTERA

EPM7064
EPM7096
EPM7128E
EPM7128S
EPM7160E

Pin 31   Pin 51

100-Pin PQFP

Pin 1 ← Pin 76

ALTERA

EPM7064S
EPM7128S
EPM7160S

Pin 26   Pin 51

100-Pin TQFP

Figure 20. 160-Pin Package Pin-Out Diagram

Package outline not drawn to scale.

EPM7192E
Bottom
View

R P N M L K J H G F E D C B A
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15

160-Pin PGA

Pin 1 ← Pin 121

ALTERA

EPM7128E
EPM7128S
EPM7160E
EPM7160S
EPM7192E
EPM7192S
EPM7256E

Pin 41 → Pin 81

160-Pin PQFP

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